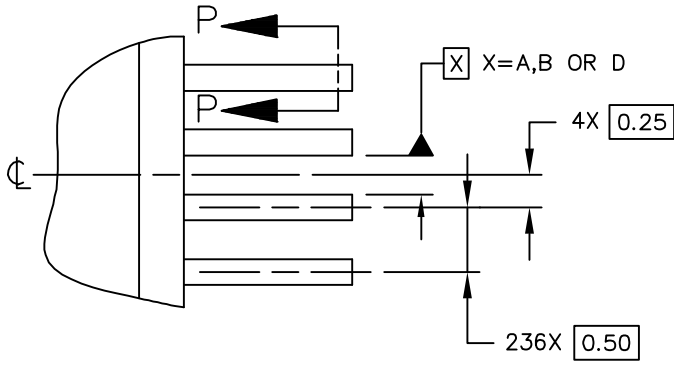
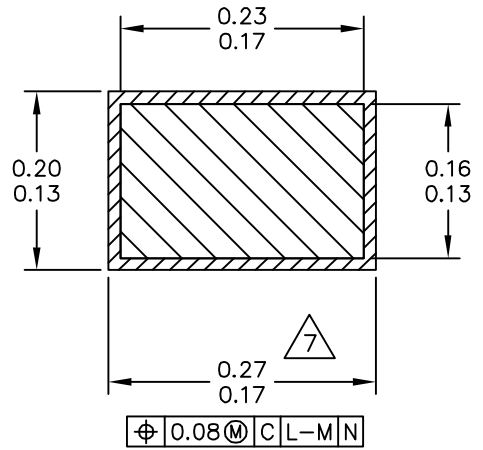


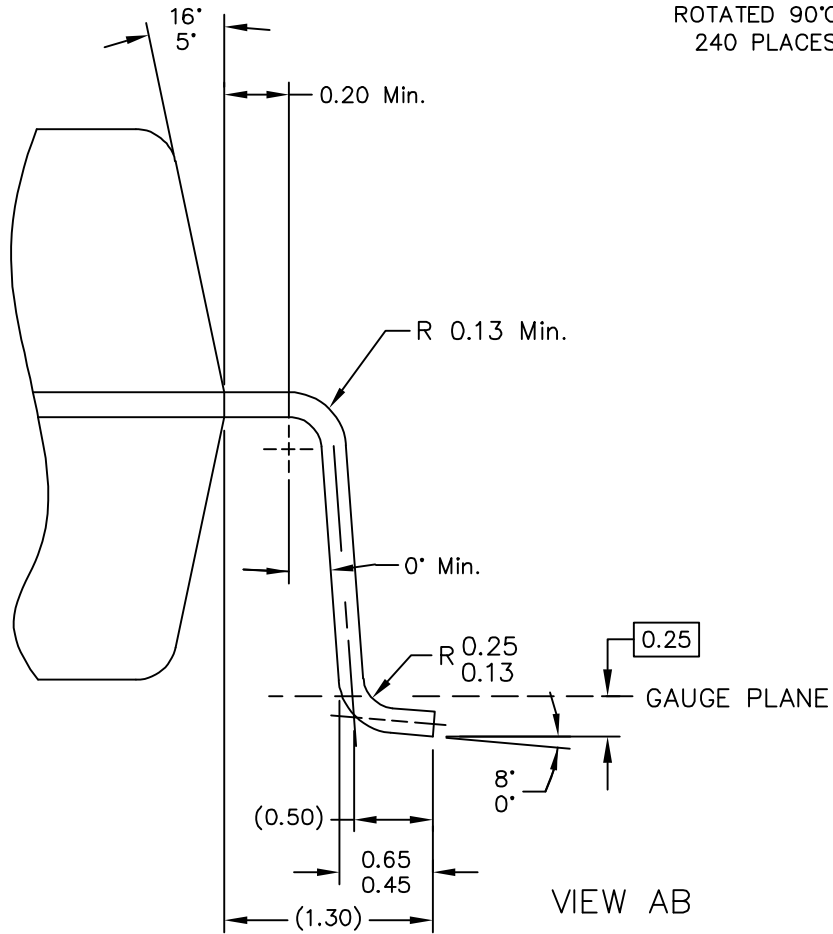
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VIEW M



SECTION P-P
ROTATED 90°CW
240 PLACES



VIEW AB

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NOTE:

- 1 DIMENSIONS AND TOLERANCING PER ASME Y14.5M–1994.
- 2 DIMENSIONS IN MILLIMETERS.
- 3 DATUM PLANE H IS LOCATED AT BOTTOM OF LEAD AND IS COINCIDENT WITH THE LEAD WHERE THE LEAD EXITS THE PLASTIC BODY AT THE BOTTOM OF THE PARTING LINE.
- 4 DATUMS A, D AND B TO BE DETERMINED AT DATUM PLANE H.
- 5 THIS DIMENSIONS TO BE DETERMINED AT SEATING PLANE, DATUM C.
- 6 THIS DIMENSIONS DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25 PER SIDE. THIS DIMENSIONS INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE H.
- 7 THIS DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL NOT CAUSE THE LEAD WIDTH TO 0.35.

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